NYCU-EE IC LAB - Spring 2024

Final Project: Innovus - From RTL to GDSII

Due to the main goal of this course is to teach students on the front-end design methodology, the APR of final project will be modified to pin design rather than pad design so it's easier.

1. Data Preparation

- 1. Complete rtl simulation, synthesis, and gate level simulation.
- 2. cd./05 APR/ write and check your CHIP.sdc file.

(Hint: you may modify the file generated during synthesize in ../02_SYN/Netlist folder, and carefully check the constraints following the check_list.pdf document.)

3. cp CPU SYN.v CHIP SYN.v and change the module name to CHIP.

(Because the design does not require any pad connection, you won't need to write your own shell file, nor do you need to execute ./00_combine.)

4. You don't need to write the CHIP.io file when you run Innovus at the first time. (The import design step should use CHIP_SYN.v and leave the CHIP.io part empty.)

Notice that TA has provided 05_APR/mmmc.view for you, please do not create mmmc.view by yourself, or you may fail in demo.

Please modify the mmmc.view file to include memory lib file:

You should include all your memory you used if you have multiple memory. create_library_set -name lib_max -timing "XX ../04_MEM/SRAM_XXX_WC.lib" ... create_library_set-name lib_min -timing "XX ../04_MEM/SRAM_XXX_BC.lib" ...

5. Open file: 05_APR/cmd/run_apr.cmd
This file sets up the initial design environment. You can use these commands
as an alternative to performing actions step-by-step via the GUI. However, the
GUI option remains available if you find it more convenient.

Notice that please add your memory LEF file PATH at the end of lefFile variable.

For example:

add ../04 MEM/XXXX.lef beyond the \$ProcessRoot/lef/BONDPAD.lef

Comment this line for the first time without CHIP.io file: set init_io_file \$ioFile

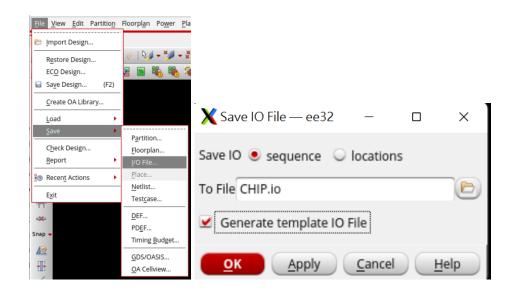
6. Launch innovus by the following command:

innovus -cpus 8 -init ./cmd/run_apr.cmd -log ./log/run_apr.log -cmd ./log/run apr.cmdlog

or make apr_init

you may find pin are gathering together due to no CHIP.io provided, thus you can do step 7 to auto generate this io file.

7. Upper left corner: FILE -> SAVE -> IO FILE -> sequence check & generate template IO file check change the file name to CHIP.io and click OK.

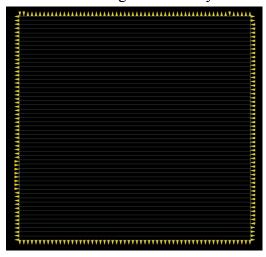


Then exit

Uncomment this line for the first time without CHIP.io file:

set init io file \$ioFile

Restart innovus again. You may see the pin shape below.



8. You may change the orders in CHIP.io file if you wish to modify your pin orders.

```
# Generated by: Cadence Innovus 20.15-s105_1
# OS: Linux x86_64(Host ID ee31)
# OS: LINUX X85_64(HOSt ID ees.

# Generated on: Mon Dec 25 21:08:16 2023

# Design: CHIP
                                                                        saveIoFile -byOrder -temp CHIP.save.io
 # Command:
 (globals
               version = 3
               io_order = default
               (pin name="clk" layer=2 width=0.2800 depth=0.7000 place_status=placed )
             (pin name="clk" layer=2 width=0.2800 depth=0.7000 place_status=placed )
(pin name="rst_n" layer=2 width=0.2800 depth=0.7000 place_status=placed )
(pin name="lo_stall" layer=2 width=0.2800 depth=0.7000 place_status=placed )
(pin name="awid_m_inf[3]" layer=2 width=0.2800 depth=0.7000 place_status=placed )
(pin name="awid_m_inf[2]" layer=2 width=0.2800 depth=0.7000 place_status=placed )
(pin name="awid_m_inf[1]" layer=2 width=0.2800 depth=0.7000 place_status=placed )
(pin name="awid_m_inf[0]" layer=2 width=0.2800 depth=0.7000 place_status=placed )
(pin name="awaddr_m_inf[31]" layer=2 width=0.2800 depth=0.7000 place_status=placed (pin name="awaddr_m_inf[29]" layer=2 width=0.2800 depth=0.7000 place_status=placed (pin name="awaddr_m_inf[28]" layer=2 width=0.2800 depth=0.7000 place_status=placed (
               (pin name="awaddr_m_inf[28]"
                                                                                                                            layer=2 width=0.2800 depth=0.7000 place_status=placed
               (pin name="awaddr_m_inf[27]"
                                                                                                                            layer=2 width=0.2800 depth=0.7000 place_status=placed
               (pin name="awaddr_m_inf[26]"
(pin name="awaddr_m_inf[25]"
                                                                                                                            layer=2 width=0.2800 depth=0.7000 place status=placed
                                                                                                                             layer=2 width=0.2800 depth=0.7000 place_status=placed
                                                                                                                              layer=2 width=0.2800 depth=0.7000 place status=place
```

9. After that, most of the steps are the same as Lab11 and Lab12. The only

difference is that there are no pads, so you should skip the step (Add PAD Filler).

2. SDC FILE

SDC file CHIP.sdc

This file is generated from 02 SYN.

You may change this to your target cycle time by yourself.

Normally, this may be equal or larger than 02_SYN due to wiring delay.

```
create_clock [get_ports clk] -period 20 -waveform {0 10}
set_clock_uncertainty 0.1 [get_clocks clk]
set_input_delay -clock clk 0 [get_ports clk]
```

Before CTS stage, you may no need to comment out the set_clock_uncertainty & set_clock_transition instruction.

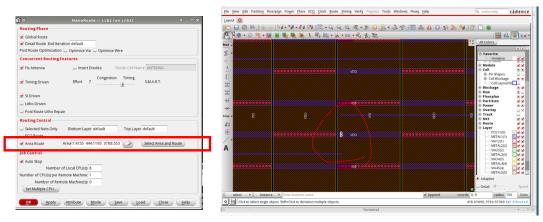
SDC file CHIP cts.sdc

The only difference of CHIP_cts.sdc is that you need to comment out the set_clock_uncertainty & set_clock_transition instruction.

Then do the CTS stage.

3. Short issue

Delete the short metal line, then use area nano route (Area Route--> Select Area and Route) to re-route that path. (sometimes may need to delete a longer metal line so the new routed result won't have short again)



4. Check Area

type > summaryReport -noHtml -outfile summaryReport.rpt then you will see the CORE area.